## SN54AHC16373, SN74AHC16373 16-BIT TRANSPARENT D-TYPE LATCHES WITH 3-STATE OUTPUTS

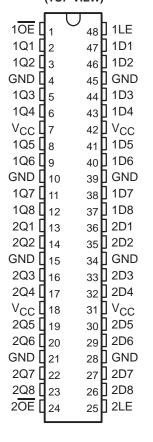
SCLS329G - MARCH 1996 - REVISED JANUARY 2000

- **Members of the Texas Instruments** Widebus™ Family
- **EPIC™** (Enhanced-Performance Implanted **CMOS) Process**
- Operating Range 2-V to 5.5-V V<sub>CC</sub>
- Distributed V<sub>CC</sub> and GND Pins Minimize **High-Speed Switching Noise**
- Flow-Through Architecture Optimizes PCB Layout
- Latch-Up Performance Exceeds 250 mA Per **JESD 17**
- **ESD Protection Exceeds 2000 V Per** MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- **Package Options Include Plastic Shrink** Small-Outline (DL), Thin Shrink Small-Outline (DGG), and Thin Very Small-Outline (DGV) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Package **Using 25-mil Center-to-Center Spacings**

#### description

The 'AHC16373 devices are 16-bit transparent D-type latches with 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. They are particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

SN54AHC16373 . . . WD PACKAGE SN74AHC16373 . . . DGG, DGV, OR DL PACKAGE (TOP VIEW)



These devices can be used as two 8-bit latches or one 16-bit latch. When the latch-enable (LE) input is high, the Q outputs follow the data (D) inputs. When LE is taken low, the Q outputs are latched at the levels at the D inputs.

A buffered output-enable (OE) input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and the increased drive provide the capability to drive bus lines without need for interface or pullup components.

To ensure the high-impedance state during power up or power down,  $\overline{\sf OE}$  should be tied to  ${\sf V}_{\sf CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

OE does not affect internal operations of the latch. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

The SN54AHC16373 is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74AHC16373 is characterized for operation from -40°C to 85°C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

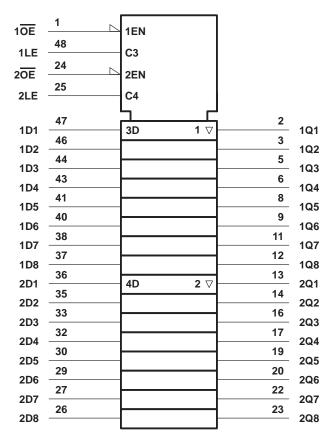
EPIC and Widebus are trademarks of Texas Instruments Incorporated.



# FUNCTION TABLE (each 8-bit latch)

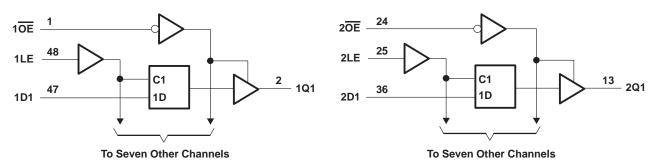
	INPUTS	ОИТРИТ	
OE	LE	D	Q
L	Н	Н	Н
L	Н	L	L
L	L	Χ	Q <sub>0</sub>
Н	Χ	Χ	Z

# logic symbol†



 $<sup>\</sup>ensuremath{^{\dagger}}$  This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

## logic diagram (positive logic)





SCLS329G - MARCH 1996 - REVISED JANUARY 2000

### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage range, V <sub>CC</sub>	–0.5 V to 7 V
Input voltage range, V <sub>I</sub> (see Note 1)	0.5 V to 7 V
Output voltage range, V <sub>O</sub> (see Note 1)	$\dots$ -0.5 V to V <sub>CC</sub> + 0.5 V
Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0)	–20 mA
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0 or V <sub>O</sub> > V <sub>CC</sub> )	±20 mA
Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )	±25 mA
Continuous current through each V <sub>CC</sub> or GND	±75 mA
Package thermal impedance, θ <sub>JA</sub> (see Note 2): DGG package	70°C/W
DGV package	58°C/W
DL package	63°C/W
Storage temperature range, T <sub>Stg</sub>	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51.

## recommended operating conditions (see Note 3)

			SN54AH	C16373	SN74AH0	16373	UNIT
			MIN	MAX	MIN	MAX	UNII
Vсс	Supply voltage		2	5.5	2	5.5	V
		V <sub>CC</sub> = 2 V	1.5		1.5		
VIH	High-level input voltage	V <sub>CC</sub> = 3 V	2.1		2.1		V
		V <sub>CC</sub> = 5.5 V	3.85		3.85		
		V <sub>CC</sub> = 2 V		0.5		0.5	
VIL	Low-level input voltage	V <sub>CC</sub> = 3 V		0.9		0.9	V
		V <sub>CC</sub> = 5.5 V		1.65		1.65	
٧ı	Input voltage	-	0	5.5	0	5.5	V
٧o	Output voltage		0.4	V <sub>CC</sub>	0	Vcc	V
		V <sub>CC</sub> = 2 V	Į.	-50		<del>-</del> 50	μΑ
ЮН	High-level output current	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$	2	9 -4 -4			mA
		$V_{CC} = 5 V \pm 0.5 V$	Q.	-8			
		V <sub>CC</sub> = 2 V		50		50	μΑ
lOL	Low-level output current	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		4		4	A
		$V_{CC} = 5 V \pm 0.5 V$		8	8		mA
44/4		$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		100		100	0/
Δt/Δv	Input transition rise or fall rate	$V_{CC} = 5 V \pm 0.5 V$		20		20	ns/V
T <sub>A</sub>	Operating free-air temperature	<u> </u>	-55	125	-40	85	°C

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

# SN54AHC16373, SN74AHC16373 16-BIT TRANSPARENT D-TYPE LATCHES WITH 3-STATE OUTPUTS

SCLS329G - MARCH 1996 - REVISED JANUARY 2000

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	Vaa	T,	ղ = 25°C	;	SN54AH0	C16373	SN74AHC	16373	UNIT
PARAMETER	TEST CONDITIONS	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
		2 V	1.9			1.9		1.9		
	I <sub>OH</sub> = -50 μA	3 V	2.9			2.9		2.9		
Voн		4.5 V	4.4			4.4		4.4		V
	I <sub>OH</sub> = -4 mA	3 V	2.58			2.48		2.48		
	I <sub>OH</sub> = -8 mA	4.5 V	3.94			3.8	N.	3.8		
		2 V			0.1		0.1		0.1	
	I <sub>OL</sub> = 50 μA	3 V			0.1	0.1			0.1	
VOL		4.5 V			0.1	6	0.1		0.1	V
	I <sub>OL</sub> = 4 mA	3 V			0.36	20	0.5		0.44	
	I <sub>OL</sub> = 8 mA	4.5 V			0.36	<sup>7</sup> 0	0.5		0.44	
lլ	V <sub>I</sub> = V <sub>CC</sub> or GND	0 V to 5.5 V			±0.1	4	±1*		±1	μΑ
loz	$V_O = V_{CC}$ or GND, $V_I = V_{IL}$ or $V_{IH}$	5.5 V			±0.25		±2.5		±2.5	μΑ
Icc	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			4		40		40	μΑ
C <sub>i</sub>	V <sub>I</sub> = V <sub>CC</sub> or GND	5 V		2.5	10				10	pF
Co	$V_O = V_{CC}$ or GND	5 V		4						pF

<sup>\*</sup> On products compliant to MIL-PRF-38535, this parameter is not production tested at  $V_{CC} = 0 \text{ V}$ .

# timing requirements over recommended operating free-air temperature range, $V_{CC}$ = 3.3 V $\pm$ 0.3 V (unless otherwise noted) (see Figure 1)

		T <sub>A</sub> = 25°C		SN54AHC16373		SN74AHC16373		UNIT
		MIN	MAX	MIN	<b>MAX</b>	MIN	MAX	UNIT
t <sub>W</sub>	Pulse duration, LE high	5		5	2011	5		ns
t <sub>su</sub>	Setup time, data before LE↓	4		4		4		ns
th	Hold time, data after LE↓	1		<b>Q</b> 1		1		ns

# timing requirements over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

			T <sub>A</sub> = 25°C		SN54AHC16373		SN74AHC16373	
		MIN	MAX	MIN	MAX	MIN	MAX	UNIT
t <sub>W</sub>	Pulse duration, LE high	5		5	100	5		ns
t <sub>su</sub>	Setup time, data before LE↓	4		4		4		ns
t <sub>h</sub>	Hold time, data after LE↓	1		र्श		1		ns

# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 3.3 V $\pm$ 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	LOAD	T	չ = 25°C	;	SN54AHC	16373	SN74AHC	16373	UNIT																			
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT																			
t <sub>PLH</sub>	D	Q	C <sub>I</sub> = 15 pF		7.3*	13*	1*	15*	1	15	ns																			
t <sub>PHL</sub>	D	Q	C[ = 15 pi		7.3*	13*	1*	15*	1	15	115																			
t <sub>PLH</sub>	LE	Q	C <sub>L</sub> = 15 pF		7*	13*	1*	15*	1	15	ns																			
tPHL	LL	Q	CL = 15 pr		7*	13*	1**	15*	1	15	110																			
t <sub>PZH</sub>	ŌĒ	Q	C 15 pE		7.3*	13*	1*	15*	1	15	ns																			
tPZL	OE	Q	C <sub>L</sub> = 15 pF		7.3*	13*	1*	15*	1	15	115																			
t <sub>PHZ</sub>	ŌĒ	Q	C 15 pE		10*	14*	1*	16*	1	16	ns																			
t <sub>PLZ</sub>	OE	Q	C <sub>L</sub> = 15 pF		10*	14*	1* 4	16*	1	16	115																			
t <sub>PLH</sub>	D	Q	C <sub>I</sub> = 50 pF		9.8	14	10	16	1	16	ns																			
tPHL	D		CL = 50 pr		9.8	14	70	16	1	16	110																			
tPLH	LE	Q	C 50 pF		9.5	14.5	æ 1	16.5	1	16.5	ns																			
tPHL	LL	α	C <sub>L</sub> = 50 pF		9.5	14.5	1	16.5	1	16.5	110																			
<sup>t</sup> PZH		0	C. 50 pF		9.3	14.9	1	16	1	16																				
tPZL	ŌĒ	Q	C <sub>L</sub> = 50 pF		8	14.9	1	16	1	16	ns																			
t <sub>PHZ</sub>		0	C. = 50 pE		10.4	15.5	1	17	1	17	ns																			
t <sub>PLZ</sub>	ŌĒ	Q	Q	Q	Q	Q	Q	Q	Q	Q	Q	Q	Q	Q	Q	Q	Q	Q	Q	Q	Q C <sub>L</sub> = 50 pF	C <sub>L</sub> = 50 pF		11.6	15.5	1	17	1	17	115
tsk(o)		·	C <sub>L</sub> = 50 pF			1.5**		·		1.5	ns																			

<sup>\*</sup> On products compliant to MIL-PRF-38535, this parameter is not production tested.

# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	LOAD	T	չ = 25°C	;	SN54AHC	16373	SN74AHC	16373	UNIT													
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT													
tPLH	D	Q	C <sub>I</sub> = 15 pF		5*	8.2*	1*	9.5*	1	9.5	ns													
tPHL	D	ų,	CL = 15 pr		5*	8.2*	1*	9.5*	1	9.5	115													
tPLH	LE	Q	C 15 pE		4.9*	8.5*	1*	9.5*	1	9.5	ns													
tPHL	LE	Q	C <sub>L</sub> = 15 pF		4.9*	8.5*	1*	9.5*	1	9.5	115													
t <sub>PZH</sub>	ŌĒ	0	C 15 pE		5.5*	9.1*	1*	10*	1	10	no													
tPZL	OE	Q	C <sub>L</sub> = 15 pF		5.5*	9.1*	1*	10*	1	10	ns													
t <sub>PHZ</sub>	ŌĒ	Q	C. 45 pF		5*	9.5*	1*	10*	1	10														
tPLZ	OE	l Q	C <sub>L</sub> = 15 pF		5*	9.5*	1* 4	10*	1	10	ns													
t <sub>PLH</sub>	D	Q	C. 50 pF		6.5	9.2	10	10.5	1	10.5														
tPHL	D		C <sub>L</sub> = 50 pF		6.5	9.2	3	10.5	1	10.5	ns													
t <sub>PLH</sub>	LE	Q	C 50 pF		6.4	9.5	& 1	10.5	1	10.5	ns													
tPHL	LE	Q	$C_L = 50 \text{ pF}$		6.4	9.5	1	10.5	1	10.5	115													
t <sub>PZH</sub>	ŌĒ	Q	C 50 pF		6	10.1	1	11.5	1	11.5	no													
tPZL	OE	Q	C <sub>L</sub> = 50 pF		6	10.1	1	11.5	1	11.5	ns													
tPHZ		0	C: - 50 pF		6.5	10.5	1	11.5	1	11.5	no													
tPLZ	ŌĒ	Q	Q	Q	Q	Q	Q	Q	Q	Q	Q	Q	Q	Q	Q C <sub>L</sub> =	C <sub>L</sub> = 50 pF		7.5	10.5	1	11.5	1	11.5	ns
tsk(o)			C <sub>L</sub> = 50 pF			1**				1	ns													

<sup>\*</sup> On products compliant to MIL-PRF-38535, this parameter is not production tested.

<sup>\*\*</sup> On products compliant to MIL-PRF-38535, this parameter does not apply.



<sup>\*\*</sup> On products compliant to MIL-PRF-38535, this parameter does not apply.

# SN54AHC16373, SN74AHC16373 **16-BIT TRANSPARENT D-TYPE LATCHES** WITH 3-STATE OUTPUTS SCLS329G - MARCH 1996 - REVISED JANUARY 2000

# noise characteristics, $V_{CC}$ = 5 V, $C_L$ = 50 pF, $T_A$ = 25°C (see Note 4)

	PARAMETER	SN74	UNIT		
	PARAMETER	MIN	TYP	MAX	UNIT
V <sub>OL(P)</sub>	Quiet output, maximum dynamic V <sub>OL</sub>		0.34	0.8	V
VOL(V)	Quiet output, minimum dynamic V <sub>OL</sub>		-0.1	-0.8	V
VOH(V)	Quiet output, minimum dynamic VOH		4.6		V
VIH(D)	High-level dynamic input voltage	3.5			V
V <sub>IL</sub> (D)	Low-level dynamic input voltage			1.5	V

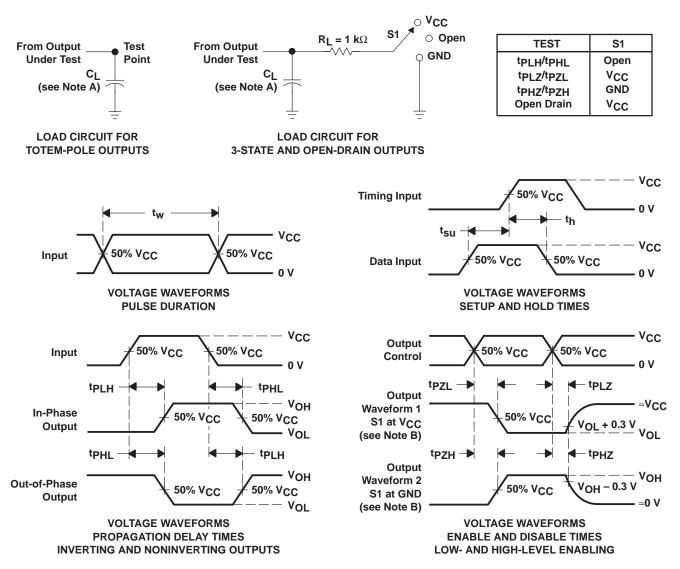
NOTE 4: Characteristics are for surface-mount packages only.

# operating characteristics, $V_{CC}$ = 5 V, $T_A$ = 25°C

	PARAMETER	TEST C	ONDITIONS	TYP	UNIT
C <sub>pd</sub> Power	dissipation capacitance	No load,	f = 1 MHz	21	pF



#### PARAMETER MEASUREMENT INFORMATION



NOTES: A.  $C_L$  includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_O = 50~\Omega$ ,  $t_f \leq 3$  ns,  $t_f \leq 3$  ns.
- D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms







#### **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
74AHC16373DGGRE4	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74AHC16373DGGRG4	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74AHC16373DGVRE4	ACTIVE	TVSOP	DGV	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74AHC16373DGVRG4	ACTIVE	TVSOP	DGV	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC16373DGGR	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC16373DGVR	ACTIVE	TVSOP	DGV	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC16373DL	ACTIVE	SSOP	DL	48	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC16373DLG4	ACTIVE	SSOP	DL	48	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC16373DLR	ACTIVE	SSOP	DL	48	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC16373DLRG4	ACTIVE	SSOP	DL	48	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

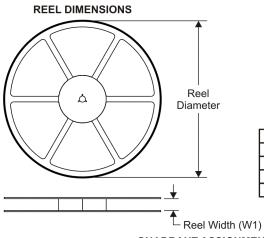
Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

# PACKAGE MATERIALS INFORMATION

www.ti.com 11-Aug-2009

## TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

## QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74AHC16373DGGR	TSSOP	DGG	48	2000	330.0	24.4	8.6	15.8	1.8	12.0	24.0	Q1
SN74AHC16373DGVR	TVSOP	DGV	48	2000	330.0	16.4	7.1	10.2	1.6	12.0	16.0	Q1
SN74AHC16373DLR	SSOP	DL	48	1000	330.0	32.4	11.35	16.2	3.1	16.0	32.0	Q1

www.ti.com 11-Aug-2009



\*All dimensions are nominal

7 III GITTIOTOTOTO GITO TTOTTIITIGI								
Device	Package Type	Package Drawing	Pins SPQ		Length (mm)	Width (mm)	Height (mm)	
SN74AHC16373DGGR	TSSOP	DGG	48	2000	346.0	346.0	41.0	
SN74AHC16373DGVR	TVSOP	DGV	48	2000	346.0	346.0	33.0	
SN74AHC16373DLR	SSOP	DL	48	1000	346.0	346.0	49.0	

#### DL (R-PDSO-G\*\*)

#### **48 PINS SHOWN**

#### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MO-118

## DGG (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE PACKAGE

#### **48 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

## DGV (R-PDSO-G\*\*)

#### 24 PINS SHOWN

#### **PLASTIC SMALL-OUTLINE**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.

D. Falls within JEDEC: 24/48 Pins – MO-153 14/16/20/56 Pins – MO-194

#### **IMPORTANT NOTICE**

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

**Applications Products Amplifiers** amplifier.ti.com Audio www.ti.com/audio Data Converters Automotive www.ti.com/automotive dataconverter.ti.com DLP® Products Broadband www.dlp.com www.ti.com/broadband DSP Digital Control dsp.ti.com www.ti.com/digitalcontrol Clocks and Timers www.ti.com/clocks Medical www.ti.com/medical Military Interface www.ti.com/military interface.ti.com Optical Networking Logic logic.ti.com www.ti.com/opticalnetwork Power Mgmt power.ti.com Security www.ti.com/security Telephony Microcontrollers microcontroller.ti.com www.ti.com/telephony Video & Imaging www.ti-rfid.com www.ti.com/video RF/IF and ZigBee® Solutions www.ti.com/lprf Wireless www.ti.com/wireless

> Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2009, Texas Instruments Incorporated